

PLASTIC HIGH-EFFICIENCY RECTIFIERS



 VOLTAGE:
 1000
 Volts

 CURRENT:
 1
 Ampers

 Package:
 DO-15
 Marking And Polarity

FEATURES

- Plane Schottky Potential Barrier Chip
- Low Forward Voltage Drop For High Efficiency
- Low Leakage Current For High Reliability
- High Forward Surge Capability For High Reliability
- High Frequency Operation

MECHANICAL DATA

- Package: Molding Compound Meets UL 94 V-0 Flammability Rating, RoHS-Compliant
- Polarity: As Marked On Case
- Mounting Position: Any
- Weight:App. 0.306 Grams (0.010791 Ounce)

TYPICAL APPLICATIONS

For Use In High Frequency Inverters, Switching Mode Power Supply
 AC/DC Converters, LED Driver Etc. Applications

BYV26EAGP



Remark:

- ①. NH=niuhang trademark
- ②. FF=Product line code,According to actual changes
- ③. BYV26EAGP=Model
- 4). White band denotes cathode

Single Phase, Half Wave, 60Hz, Resistive Or Inductive Load. For Capacitive Load, Derate Current By 20%

Maximum Ratings (Ta=25℃ Unless otherwise specified)

9- (=				
Parameter	Test Conditions	Symbol	BYV26EAGP	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	1000	٧
Maximum RMS Voltag		V _{RMS}	700	٧
Maximum DC Blocking Voltage		V _{DC}	1000	٧
Maximum Average Forward Rectified Current	@TC= 100 °C	I _{F(AV)}	1	Α
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I _{FSM}	30	Α
Current Squared Time Per Diode	t<8.3ms	l ² t	3.7	A ² sec

Electrical Characteristcs (Ta=25°C Unless otherwise specified)

Parameter	Test Conditions		Symbol	BYV26EAGP			11.2
Parameter				Min.	Тур.	Max.	Unit
Instanceus forward voltage per diede (note1)	Ta=25℃	I _F = 1.0 A V _I	V _F		1.40	2.00	v
Instaneous forward voltage per diode (note1)	Ta=125℃				1.30	1.90	
Maximum DC Reverse Current at Rated DC	Ta=25℃	$V_R = V_{RRM}$			1	5	uA
Blocking Voltage (Note 1)	Ta=125℃	V _R = 80%*V _{RRM}	I _{RRM}	-	100	500	UA
Typical Junction Capacitance Per Diode	4.0	V,1MHz	C ¹		15		pF
Maximum Reverse Recovery Time	I _E =0.5A, I _R =	1.0A, I _{RR} =0.25A	T _{RR}			50	nS

Thermal Characteristcs (Ta=25℃ Unless otherwise specified)

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Parameter	Symbol	I BYV26EAGP			Unit	
Operating Junction Temperature Range	T₃	-55	to	150		\$
Storage Temperature Range	T _{STD}	-55	to	150		C
Tuning I thormal registance (Note 2)	$R_{\theta JA}$	R _{8JA} 65			℃/ W	
Typical thermal resistance (Note 2)	Reic	c 16				

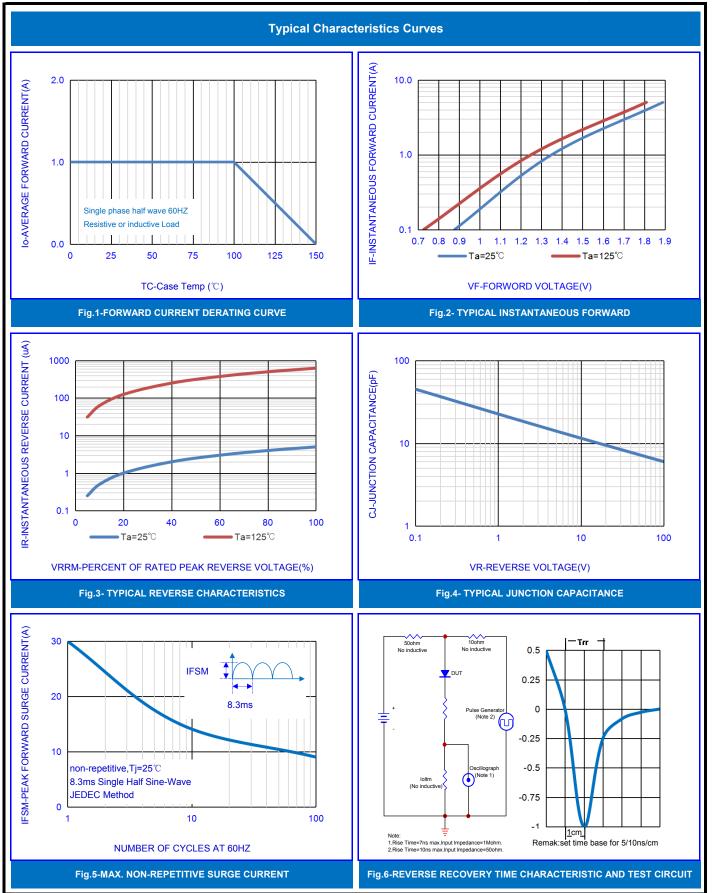
Notes: 1.Pulse Test: 300 Us Pulse Width,2% Duty Cycle

2.Hermal Resistance from Junction to Ambient at 3/8"lead length, P.C. Board Mounted

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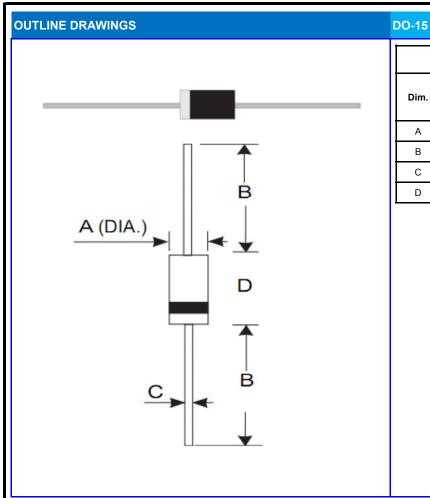






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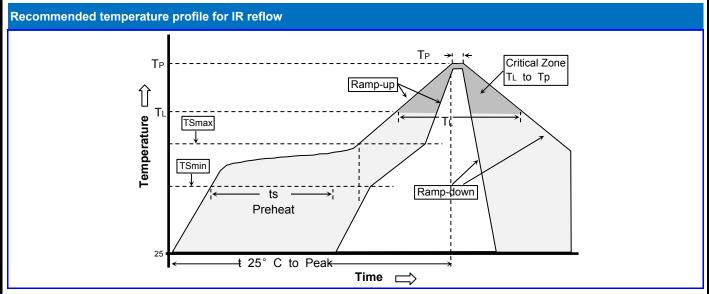
1							
OUTLINE DIMENSIONS							
Dim.	Milimeters			Inches			
5	Min.	Тур.	Max.	Min. Typ.		Max.	
Α	2.6	-	3.6	0.104	-	0.140	
В	24.0	-	27.0	0.945	-	1.063	
С	0.7	-	0.9	0.028	1	0.035	
D	5.8	-	7.6	0.230	-	0.300	

PACKING INFORMATION							
Package Code	Package Method	Inner Box Size L×W×H(mm)	Quantity (Pcs/Inner Box)	Outer Carton Size L×W×H(mm)	Quantity (Pcs/Carton)		
DO-15	Braided/boxed	250x75x140	3000	420x280x310	30000		



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Recommended wave soldering condition						
Product	Peak Temperature	Soldering Time				
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds				



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



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